## SN5426, SN54LS26, SN7426, SN74LS26 QUADRUPLE 2-INPUT

**SDLS087** 

HIGH-VOLTAGE INTERFACE POSITIVE-NAND GATES DECEMBER 1983-REVISED MARCH 1988

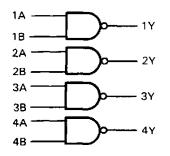
 For Driving Low-Threshold-Voltage MOS Inputs

#### description

These 2-input open-collector NAND gates feature high-output voltage ratings for interfacing with low-threshold-voltage MOS logic circuits or other 12-volt systems. Although the output is rated to withstand 15 volts, the V<sub>CC</sub> terminal is connected to the standard 5-volt source.

The SN5426 and SN54LS26 are characterized for operation over the full military temperature range of -55 °C to 125 °C. The SN7426 and SN74LS26 are characterized for operation from 0 °C to 70 °C.

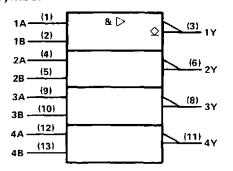
#### logic diagram



positive logic

 $Y = \overline{AB}$ 

logic symbol<sup>†</sup>

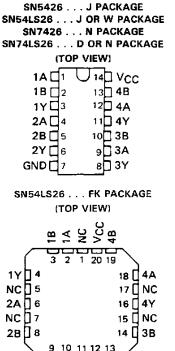


<sup>†</sup> This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

Pin numbers shown are for D, J, N, and W packages.

PRODUCTION DATA documents contain information current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

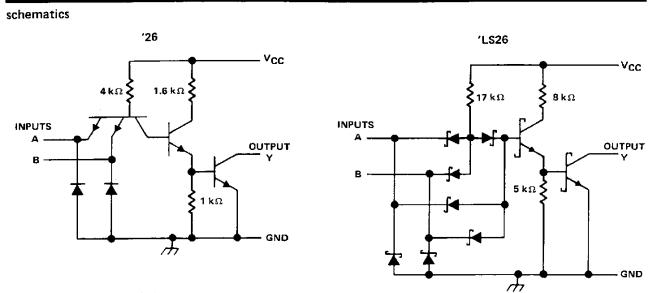




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NC - No internal connection

### SN5426, SN54LS26, SNSN7426, SN74LS26 QUADRUPLE 2-INPUT HIGH-VOLTAGE INTERFACE POSITIVE-NAND GATES



Resistor values shown are nominal.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage , V <sub>CC</sub> (see Note 1)	
Input voltage: '26	
'LS26	
Operating free-air temperature: SN54'	$ = 55^{\circ}C$ to $125^{\circ}C$
SN74'	0°C to 70°C
Storage temperature range	

NOTE 1: Voltage values are with respect to network ground terminal.



### SN54LS26, SN74LS26 QUADRUPLE 2-INPUT HIGH-VOLTAGE INTERFACE POSITIVE-NAND GATES

#### recommended operating conditions

ì

	s	SN54LS26			SN74LS26			
	MIN NOM MAX MIN NOM MAX	UNIT						
V <sub>CC</sub> Supply voltage	4.5	5	5.5	4.75	5	5.25	V	
VIH High-level input voltage	2			2			V	
VIL Low-level input voltage			0.7			0.8	V	
VOH High-level output voltage			15			15	V	
OL Low-level output current			4			8	mA	
TA Operating free-air temperature	- 55		125	0		70	°C	

### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		S	N54LS	26	S	26	UNIT			
PANAMETER		TEST CONDIT		MIN	TYP‡	MAX	MIN	TYP‡	MAX	
VIK	V <sub>CC</sub> = MIN,	l <sub>l</sub> = 18 mA				- 1.5			- 1.5	V
1-	V <sub>CC</sub> = MIN,	VIL = MAX,	V <sub>OH</sub> = 12 V			50			50	μA
юн	V <sub>CC</sub> = MIN,	VIL = MAX,	V <sub>OH</sub> = 15 V			1			1	mA
17	V <sub>CC</sub> = MIN,	V <sub>1H</sub> = 2 V,	IOL = 4 mA		0.25	0.4		0.25	0.4	
VOL	V <sub>CC</sub> = MIN,	V <sub>1H</sub> ≈ 2 V,	IOL = 8 mA					0.35	0.5	V
1	V <sub>CC</sub> = MAX,	V1 = 7 V	·····			0.1			0.1	mΑ
ЧН	V <sub>CC</sub> = MAX,	V <sub>IH</sub> = 2.7 V				20			20	μA
<sup>4</sup> IL	V <sub>CC</sub> = MAX,	V <sub>IL</sub> = 0.4 V	····			- 0.4			- 0.4	mА
ІССН	V <sub>CC</sub> = MAX,	V   = 0			0.8	1.6		0.8	1.6	mA
CCL	V <sub>CC</sub> = MAX,	V   = 4.5 V			2.4	4.4		2,4	4.4	

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions. ‡ All typical values are at  $V_{CC} = 5 V$ ,  $T_A = 25^{\circ}C$ .

switching characteristics,  $V_{CC} = 5 V$ ,  $T_A = 25^{\circ}C$  (see note 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS		YP MAX	UNIT
1PLH	A or B	Y	$R_L = 2 k\Omega$ , $C_L = 15 pF$	<u> </u>	17 32	ns
<sup>t</sup> ₽HL					15 28	ns

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.



### SN5426, SN7426 QUADRUPLE 2-INPUT HIGH-VOLTAGE INTERFACE POSITIVE NAND GATES

#### recommended operating conditions

		SN5426					
	MIN	NOM	MAX	MIN	NOM	MAX	ONT
VCC Supply voltage	4.5	5	5.5	4.75	5	5.25	V
VIH High-level input voltage	2			2			v
VIL Low-level input voltage			0.8			0.8	v
VOH High-level output voltage			15			15	V
IOL Low-level output current			16			16	mΑ
T <sub>A</sub> Operating free-air temperature	- 55		125	0		70	°C

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	TEST CONDITIONS <sup>†</sup>	SN5426	\$N7426	
PARAMETER		MIN TYP <sup>‡</sup> MAX	MIN TYP <sup>‡</sup> MAX	UNIT
VIK	$V_{CC} = MIN, I_{I} \approx -12 mA$	- 1.5	- 1.5	V
	$V_{CC} = MIN, V_{IL} = 0.8 V, V_{OH} = 12 V$		50	
la	$V_{CC} = MIN$ , $V_{IL} = 0.7 V$ , $V_{OH} = 12 V$	50		μA
юн	$V_{CC} = MIN, V_{IL} = 0.8 V, V_{OH} = 15 V$		1	4
	$V_{CC} = MIN, V_{IL} = 0.7 V, V_{OH} = 15 V$	1		mΑ
VOL	$V_{CC} = MIN$ , $V_{IH} = 2V$ , $I_{OL} = 16 mA$	0.4	0.4	V
<u>ц</u>	$V_{CC} = MAX$ , $V_I = 5.5 V$	1	1	mA
ин	$V_{CC} = MAX, V_I = 2.4 V$	40	40	μA
י <u>ו</u> נ	$V_{CC} = MAX, V_{I} = 0.4 V$	- 1.6	- 1.6	mΑ
ССН	$V_{CC} = MAX, V_{I} = 0$	4 8	4 8	mA
ICCL	$V_{CC} = MAX, V_I = 4.5 V$	12 22	12 22	mΑ

<sup>†</sup>For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions. <sup>‡</sup>All typical values are at  $V_{CC} = 5 V$ ,  $T_A = 25 °$ C.

### switching characteristics, $V_{CC} = 5 V$ , $T_A = 25^{\circ}C$ (see note 2)

PARAMETER	FROM (INPUT)	TQ (OUTPUT)	TEST CONDI	MIN	түр	MAX	UNIT	
tPLH	A or B	×	Řι = 1 kΩ,	C <sub>1</sub> = 15 pF		16	24	ns
<sup>T</sup> PHL		•		с <u>Г - тэр</u> ь		11	17	ńs

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.



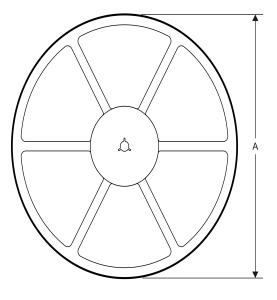
## PACKAGE MATERIALS INFORMATION

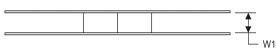
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### TAPE AND REEL INFORMATION

#### REEL DIMENSIONS

TEXAS INSTRUMENTS





#### TAPE DIMENSIONS



A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

## TAPE AND REEL INFORMATION

\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74LS26DR	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1

TEXAS INSTRUMENTS

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## PACKAGE MATERIALS INFORMATION

14-Jul-2012



\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74LS26DR	SOIC	D	14	2500	367.0	367.0	38.0

W (R-GDFP-F14)

CERAMIC DUAL FLATPACK



- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. This package can be hermetically sealed with a ceramic lid using glass frit.
  - D. Index point is provided on cap for terminal identification only.
  - E. Falls within MIL STD 1835 GDFP1-F14



## **GENERIC PACKAGE VIEW**

## CDIP - 5.08 mm max height

CERAMIC DUAL IN LINE PACKAGE



Images above are just a representation of the package family, actual package may vary. Refer to the product data sheet for package details.



## J0014A



## **PACKAGE OUTLINE**

### CDIP - 5.08 mm max height

CERAMIC DUAL IN LINE PACKAGE



NOTES:

- 1. All controlling linear dimensions are in inches. Dimensions in brackets are in millimeters. Any dimension in brackets or parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
- 2. This drawing is subject to change without notice.
- 3. This package is hermitically sealed with a ceramic lid using glass frit.
- Index point is provided on cap for terminal identification only and on press ceramic glass frit seal only.
  Falls within MIL-STD-1835 and GDIP1-T14.



## J0014A

## **EXAMPLE BOARD LAYOUT**

### CDIP - 5.08 mm max height

CERAMIC DUAL IN LINE PACKAGE





D (R-PDSO-G14)

PLASTIC SMALL OUTLINE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AB.





NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
  E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



## N (R-PDIP-T\*\*)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- $\triangle$  The 20 pin end lead shoulder width is a vendor option, either half or full width.



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